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Columns formed by multiple twinning in nickel layers—An approach of grain boundary engineering by electrodeposition

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Complementary microscopic and diffraction based methods revealed a peculiar microstructure of electrodeposited nickel. For the as-deposited layer, thus, without any additional treatment, multiple twinning yields a high population of $\Sigma 3^n$ boundaries, which interrupts the network of normal high angle grain boundaries. A peculiar arrangement of $\Sigma 3$ boundaries forming five-fold junctions is observed. The resulting microstructure meets the requirements for grain boundary engineering. Twinning induced effects on the crystallographic orientation of grains result in one major texture component being a $\langle 210 \rangle$ fiber axis and additional minor orientations originating from first and second generation twins of $\langle 210 \rangle$, i.e., $\langle 542 \rangle$ and $\langle 201 \rangle$. © 2013 AIP Publishing LLC [http://dx.doi.org/10.1063/1.4816257]

Grain boundaries play a significant role in the properties of polycrystalline materials.1 Traditional materials processing has mainly aimed to control the grain size, i.e., the number of grain boundaries. More important than their number, however, is the characteristics of grain boundaries as the key for designing and controlling functional properties. Hence, materials with high fraction of special boundaries have been produced for industrial applications.2 Low energy boundaries, and most notably $\Sigma 3$ boundaries3 are of high importance to design grain-boundary-specific materials properties.4,5 In this respect, materials are defined as “grain boundary engineered” if a high fraction of $\Sigma 3^n$ (n is an integer) boundaries is present and networks of normal high angle grain boundaries are interrupted.9 Utilizing numerous nano-twin lamellae enveloped in sub-micron-sized grains, has been reported on the example of copper to bring about an improvement of the mechanical strength without reducing ductility and without affecting physical properties, e.g., electrical conductivity.8 Furthermore, such a microstructure with numerous nano-twins has a much higher thermal stability than a nanocrystaline microstructure of equal average crystallite size, but without twins.9,10 Hence, twinning is of crucial importance for the synthesis of materials with tailored properties.

Nickel layers are characterized by high wear resistance, relatively high hardness, barrier properties, high corrosion resistance, and ease of synthesis.11 Accordingly, a large portion of overall nickel used worldwide is in the form of thin coatings, electrodeposition being the most common metal plating process.12 Optimizing electrodeposition conditions to tailor the grain boundaries and, thus, associated properties in nickel electrodeposits are of high interest. A Watts electrolyte, sometimes modified by additives, is the most widely used electrolyte for nickel electrodeposition.11 Extensive studies have been carried out since the 70 s and 80 s to understand the relation between electrochemistry of the deposition process and microstructure development in the deposits of Watts-based electrolytes.13–16 For an additive free electrolyte, it has been shown that four major fiber textures can develop: $\langle 100 \rangle$, $\langle 110 \rangle$, $\langle 211 \rangle$, and $\langle 210 \rangle$, depending on the combination of the electrolyte’s pH-value and the applied current density.13 Among them, $\langle 210 \rangle$ is the least studied; although a peculiar faceted microstructure of a $\langle 210 \rangle$ textured nickel electrodeposit is reported,17 nickel films with a preferred $\langle 210 \rangle$ orientation are not investigated in detail until now.

The present work reports about grain boundaries and multiple twinning of a 16.5 $\mu$m-thick nickel layer with $\langle 210 \rangle$ fiber texture, electrodeposited onto an amorphous Ni-P substrate. Electrodeposition was carried out from a Watts electrolyte consisting of 300 g/dm$^3$ NiSO$_4 \cdot 7$H$_2$O, 35 g/dm$^3$ NiCl$_2 \cdot 6$H$_2$O, and 40 g/dm$^3$ H$_3$BO$_3$. The pH of the electrolyte was 2.5, vigorous mechanical stirring was applied and the deposition temperature was kept constant at 323 K during electrodeposition. The applied current density was 10 A/dm$^2$.

For quantitative crystallographic texture analysis, X-ray diffraction (XRD) pole figures of 111, 200, and 220 reflections were measured with Cu-K$\alpha$-radiation (Diffractometer D8 Discover, Bruker AXS). The azimuth angle $\varphi$ was varied from 0° to 360° in steps of 5°; the sample tilt given by the pole angle $\psi$ was varied from 0° to 75° in steps of 5°. Measured intensities were corrected for background and a Ni-powder standard was used for defocusing correction. Following,18 the complete 3D orientation distribution function was calculated, but as the sample has a fiber texture in the direction of layer growth (normal direction, ND), the inverse pole figure in ND fully characterizes the texture in the deposit. As shown in Fig. 1(a), the major texture component is $\langle 210 \rangle$ with an orientation density of 3.8 m.r.d. (multiples of random distribution). This fiber texture is rather broad with a deviation of 9.4° around the ideal fiber axis. In addition to the major $\langle 210 \rangle$, two minor components close to $\langle 542 \rangle$ and $\langle 711 \rangle$ with orientation densities of 1.4 and 1.2 m.r.d., respectively, are identified. Calculating the twin orientation relations in FCC shows that these three orientations are related to one another by a twinning operation. The first generation of twins originating from $\langle 210 \rangle$ is either $\langle 210 \rangle$ or $\langle 542 \rangle$; and the first generation of twins from $\langle 542 \rangle$
In Fig. 1(b), a slight deviation from the calculated orientation (in both cases, a grain was defined as a region consisting of at least four connected points with misorientations of less than 5°), (iii) all the data points with confidence index below 0.1 were disregarded. The ICI investigation was performed using Ga⁺ ions with an energy of 30 keV and ion density of 2.6 C/m² on the same location, where the orientation map was acquired beforehand for supplementary characterization at higher resolution. Images covering the whole thickness of the deposit are shown in Fig. 2. Based on the ion channeling image (Fig. 2(a)), the grain size is estimated to be below 50 nm in the near-interface region (the first 1 μm) of the layer. Consequently, in this region no reliable information was obtained with EBSD for the current conditions, as is reflected by the ragged appearance and the relatively many non-indexed pixels (white regions in the orientation map, Fig. 2(b)). At a thickness of 1 μm, relatively large grains with characteristic straight boundaries have developed. With increasing distance from the substrate, the grain size increases, but the same characteristic straight boundaries remain. The orientation map in Fig. 2(b) shows that most of those straight boundaries are Σ3 boundaries (shown in black). Furthermore, it shows that the microstructure is composed of (210) oriented columns (yellow to yellowish green) and that the (210) oriented columns consist of a chain of (210) oriented grains, which are separated by Σ3 boundaries and, thus, must be a result of repeated and multiple twinning. In Fig. 3, one column of (210) oriented grains and its neighboring grains is highlighted and shown as an orientation map (Fig. 3(a)). It is evident from Fig. 3(a) that a (210) oriented grain is twinned into another (210) oriented grain, which at its turn twins into another (210) grain. Accordingly, a column dominated by (210) oriented grains is the result of (210)→(210) twinning. Clearly (542) oriented grains (in light blue/purple color) are bounding the (210) oriented...
column and are separated from the \langle 210 \rangle grains by a \Sigma 3 boundary. Moreover, it is observed that \langle 542 \rangle oriented grains either have a \langle 210 \rangle or another \langle 542 \rangle oriented grain as their direct neighbor. Thus, it appears that \langle 542 \rangle grains do not form independently but rather are the result of twinning of a \langle 210 \rangle or another \langle 542 \rangle grain (\langle 210 \rangle \rightarrow \langle 542 \rangle \rightarrow \langle 542 \rangle). The \langle 20 2 1 \rangle grains (in reddish colors) also have a \langle 542 \rangle oriented grain as a neighbor, and a \Sigma 3 boundary separates the two grains. This shows that \langle 20 2 1 \rangle is also the result of twinning, \langle 210 \rangle \rightarrow \langle 542 \rangle \rightarrow \langle 20 2 1 \rangle. Interestingly, Fig. 3(a) reveals \Sigma 3 boundaries between \langle 20 2 1 \rangle oriented grains (in reddish color) and \langle 551 \rangle oriented grain (in dark green color). These two orientations are also in twin relation. This indicates that even the third generation of twins of \langle 210 \rangle grains is present locally. In the texture investigation with XRD (Fig. 1(a)), the population of \langle 551 \rangle oriented grains does not exceed random distribution. Accordingly, the population of third generation twins is not of significance in this material.

Since multiple twinning is evidently has occurred in the studied material, a high fraction of \Sigma 3\nu boundaries is expected in the microstructure. Averaging the length fraction of \Sigma 3\nu boundaries over the layer thickness, 54.3% of all high angle grain boundaries are in fact of \Sigma 3\nu character. Importantly, for larger distances from the film/substrate interface the length fraction of \Sigma 3\nu boundaries is higher than the average, e.g., for the upper 12 \mu m of the layer it is above 60%. In addition, the network of normal high angle grain boundaries is interrupted; i.e., there is no passage of normal high angle grain boundaries from the substrate to the surface (see Fig. 2(c)). Thus, the two requirements of grain boundary engineered material, i.e., (i) high population of \Sigma 3\nu boundaries and (ii) interrupted networks of normal high angle grain boundaries are satisfied for the 16.5 \mu m-thick electrodeposited nickel layer. Notably, the grain boundary engineered microstructure is achieved in the as-deposited state and, in contrast to iterative thermomechanical treatments, no further post-deposition treatment is required to achieve such a high population of special boundaries in the present electrodepos. It is noted that by increase of film thickness, population of \Sigma 3\nu boundaries and grain size increases. The former is beneficial for enhanced grain boundary specific properties, whereas the latter is deteriorating mechanical strength. Hence, thickness should be optimized as a trade of between the two for different applications. In addition to thickness, careful selection of electrodeposition conditions can significantly influence multiple twinning and, hence, the resulting microstructure. The origin of multiple twinning is not completely understood yet. For the applied deposition conditions, i.e., low pH and high current density, hydrogen evolution is favored. Thus, it is suggested that the evolution of H2 at the cathode/electrolyte interface plays a role.

A peculiar observation is that in the regions with abundant \Sigma 3 boundaries a five-fold junction of straight boundaries occurs. In Fig. 3(b), a network of grain boundaries in such a region is shown and two of the five-fold junctions are marked by the black rectangles. EBSD analysis identified the occurrence of \Sigma 9 boundaries, with length of 2–3 pixels (50–75 nm) in the center of a five-fold junction of \Sigma 3 boundaries. Altogether five \Sigma 3 boundaries meeting in a single point would span a total angle of 352.6°, only 7.4° from a full rotation. Then, it might be suggested that the closing angle of 7.4° is compensated by the occurrence of a small \Sigma 9 boundary, so that no actual five-fold junction occurs. However, TEM investigations in a Titan 80–300 filed emission TEM, from FEI operated at 300 KV, in HAADF-STEM mode, show that the five boundaries actually do meet in the center of five-fold junctions, see Fig. 3(c). Hence, the \Sigma 9 boundaries identified in the orientation map at the center of a five-fold junction are merely an artifact, caused by the choice of a hexagonal grid for measurement of the orientation map (up to 3 boundaries can meet in one point in such a grid). Thorough analysis of \Sigma 9 boundaries as well as the thermal stability of the layers consisting of numerous and multiple twins are of high importance and will be addressed elsewhere.

Summarizing, it was demonstrated by combining XRD texture measurements and local orientation analysis by EBSD that electrodeposition of nickel from a highly acidic Watts electrolyte and high current density, results in multiple twinning of \langle 210 \rangle oriented grains. This yields the development of peculiar \langle 210 \rangle columns with sequences of twins within individual columns and, thus, a high number of \Sigma 3 boundaries separating the grains forming these columns. Finally, by careful selection of electrodeposition conditions, grain boundary engineered material can be achieved.

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